GaAs MMIC MSOP8 T/R SWITCH 5.5 - 6.5 GHz

FEBRUARY 1998

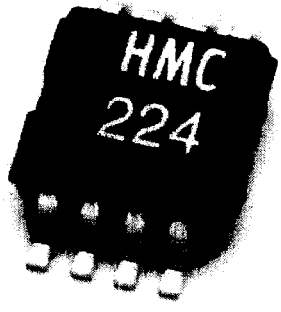
Features

INDUSTRY FIRST LOW COST 5.8 GHz SWITCH

ULTRA SMALL PACKAGE: MSOP8

HIGH INPUT P1dB: +33 dBm

SINGLE POSITIVE SUPPLY: +3 TO +8V



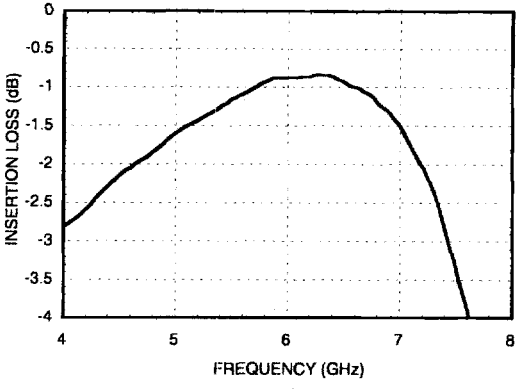
General Description

The HMC224MS8 is a low-cost SPDT switch in an 8-lead MSOP package for use in transmit-receive applications. A low cost reliable switching function is offered for medium to high signal power levels. The device can control signals from 5.5 to 6.5 GHz and is especially suited for 5.8 GHz ISM applications with only 0.8 dB loss. The design provides exceptional power handling performance; providing a +33dBm input P1dB at 5 Volt bias. RF1 or RF2 is a reflective short when "Off". On-chip circuitry allows single positive supply operation at very low DC current with control inputs compatible with CMOS and most TTL logic families. HMC224MS8 is especially suited for PCMCIA wireless LAN applications.

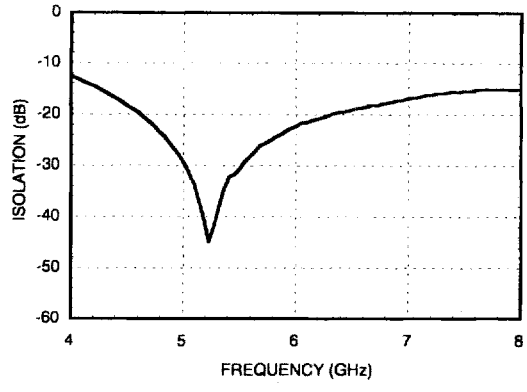
Electrical Performance, *Vdd = +5 Vdc, 50 Ohm System, -40 to +85 deg C*

Parameter		Frequency	Min.	Typ.	Max.	Units
Insertion Loss		5.5 - 6.5 GHz 5.7 - 5.9 GHz		0.9 0.7	1.4 1.1	dB dB
Isolation		5.5 - 6.5 GHz 5.7 - 5.9 GHz	16 20	22 24		dB dB
Return Loss	RF Common RF1 &RF2	5.5 - 6.5 GHz 5.5 - 6.5 GHz	6 13	9 16		dB dB
Input Power for 1dB Compression	0/3V Control 0/5V Control	5.5 - 6.5 GHz 5.5 - 6.5 GHz	28 30	31 33		dBm dBm
Input Third Order Intercept	0/3V Control 0/5V Control	5.5 - 6.5 GHz 5.5 - 6.5 GHz		40 42		dBm dBm
Switching Characteristics	tRISE, tFALL (10/90% RF) tON, tOFF (50% CTL to 10/90% RF	5.5 - 6.5 GHz		10 25		nS nS

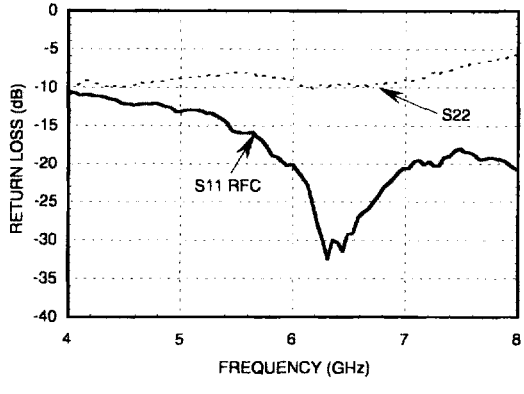
Insertion Loss



Isolation



Return Loss



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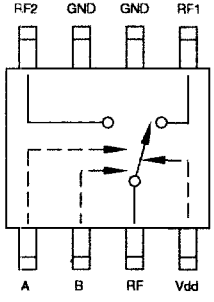
Functional Diagram



Truth Table

Control Input Voltage Tolerances are ± 0.2 Vdc

Bias	Control Input *		Bias Current	Control Current	Control Current	Signal Path State	
Vdd (Vdc)	A (Vdc)	B (Vdc)	Ivdd (µA)	Ia (µA)	Ib (µA)	RF to RF1	RF to RF2
3	0	0	10	-5	-5	OFF	OFF
3	0	Vdd	10	-10	0	ON	OFF
3	Vdd	0	10	0	-10	OFF	ON
5	0	0	45	-22	-23	OFF	OFF
5	0	Vdd	45	-5	-40	ON	OFF
5	Vdd	0	115	-40	-5	OFF	ON

Absolute Maximum Ratings

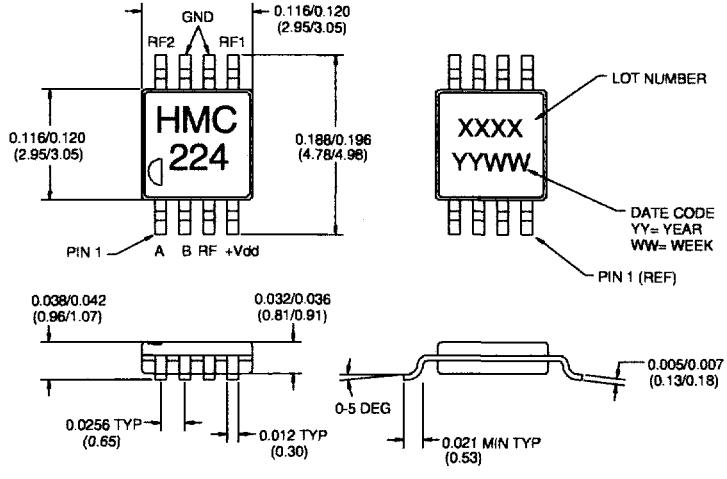
Bias Voltage Range (Vdd)	-0.2 to +12 Vdc
Control Voltage Range (A & B)	-0.2 to +Vdd Vdc
Storage Temperature	-65 to +150 deg C
Operating Temperature	-40 to +85 deg C

Caution: Do not operate in 1dB compression at power levels above +33 dBm and do not 'hot switch' power levels greater than +23dBm (V_{dd} = +5Vdc). DC blocks are required at ports RFC, RF1 and RF2.

7

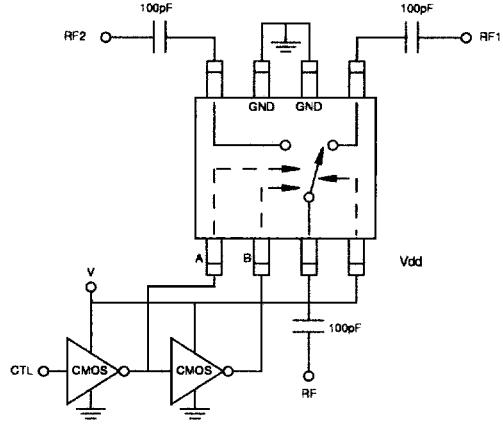
Switches

Outline



1) MATERIAL:
   A) PACKAGE BODY: LOW STRESS INJECTION MOLDED PLASTIC, SILICA & SILICONE IMPREGNATED
   B) LEADFRAME MATERIAL: COPPER ALLOY
2. PLATING: LEAD-TIN SOLDER PLATE
3. DIMENSIONS ARE IN INCHES (MILLIMETERS)

Typical Application Circuit



Notes:

1. Control inputs A and B can be driven directly with CMOS logic (HC) with V of 3 to 8 Volts applied to the CMOS logic gates and to pin 4 of the RF switch.
2. DC Blocking capacitors are required for each RF port as shown. Capacitor value determines lowest frequency of operation.
3. Highest RF signal power capability is achieved with V set to +10V. However, the switch will operate properly (but at lower RF power capability) at bias voltages down to +3V.
4. Set V to 5 Volts and use HCT series logic to provide a TTL driver interface.